April 2019

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30V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON) max}	I _D T _A = +25°C
001/	$30m\Omega$ @ $V_{GS} = 10V$	6A
30V	42mΩ @ V _{GS} = 4.5V	5A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

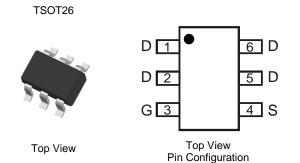
- DC-DC Converters
- Power Management Functions
- Backlighting

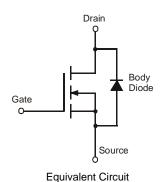
Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.013 grams (Approximate)





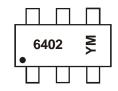
Ordering Information (Note 4)

Part Number	Case	Packaging
DMG6402LVT-7	TSOT26	3,000/Tape & Reel
DMG6402LVT-13	TSOT26	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



6402 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Year	201	1	~		2019	20	20	2021		2022	2	2023
Code	Υ		~		G		Н			J		K
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	1	5	6	7	Ω	Q	0	N	ב



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Durin Courset (Note 5) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.0 4.8	А
Continuous Drain Current (Note 5) V _{GS} = 10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	7.5 5.9	А
Continuous Durin Courset (Note 5) V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	5.0 4.0	А	
Continuous Drain Current (Note 5) V _{GS} = 4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6 4.8	А
Maximum Body Diode Forward Current (Note 5)	Is	2	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	31	А		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	C-	1.75	W	
Total Fower Dissipation (Note 5)	$T_A = +70^{\circ}C$	P_D	1.1	۷V	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	0	72	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	50		
Thermal Resistance, Junction to Case (Note 5)	$R_{ heta JC}$	23			
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C	

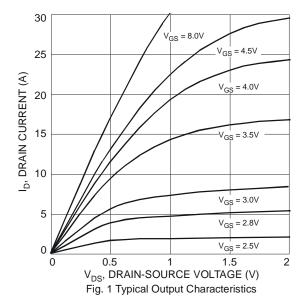
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

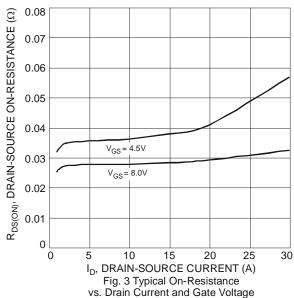
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)								
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	V _{GS(TH)}	1	1.5	2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$		
Static Drain-Source On-Resistance			22	30	mΩ	$V_{GS} = 10V, I_D = 7A$		
Static Diani-Source On-Nesistance	R _{DS(ON)}		32	42	11122	$V_{GS} = 4.5V, I_D = 5.6A$		
Forward Transfer Admittance	Y _{fs}		10	_	S	$V_{DS} = 5V, I_{D} = 7A$		
Diode Forward Voltage	V_{SD}	_	0.75	1.0	V	$V_{GS} = 0V$, $I_S = 1A$		
DYNAMIC CHARACTERISTICS (Note 7)								
Input Capacitance	Ciss		498	_		15)/)/ 0)/		
Output Capacitance	Coss	_	52	_	pF	$V_{DS} = 15V, V_{GS} = 0V$ f = 1.0MHz		
Reverse Transfer Capacitance	C _{rss}	_	45	_		1 = 1.0IVII IZ		
Gate Resistance	R _G	_	2.4	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$		
Total Gate Charge	Q_g	_	11.4	_				
Gate-Source Charge	Qgs	_	1.4	_	nC	$V_{GS} = 10V, V_{DS} = 15V, I_D = 5.8A$		
Gate-Drain Charge	Q _{gd}	_	2	_				
Turn-On Delay Time	t _{D(ON)}	_	3.4	_				
Turn-On Rise Time	t _R	_	6.2	_		$V_{DD} = 15V, V_{GS} = 10V,$		
Turn-Off Delay Time	t _{D(OFF)}	_	13.9		ns	$R_L = 2.6\Omega$, $R_G = 3\Omega$		
Turn-Off Fall Time	t _F	_	2.8	_				

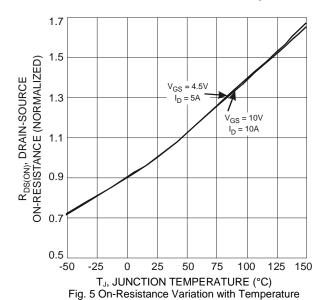
Notes:

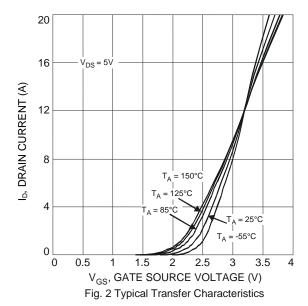
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Guaranteed by design. Not subject to production testing.











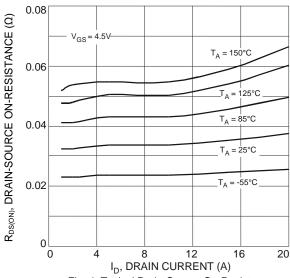


Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

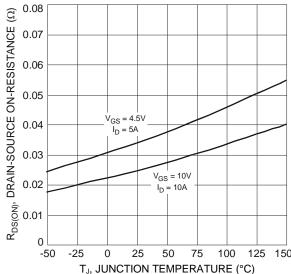


Fig. 6 On-Resistance Variation with Temperature



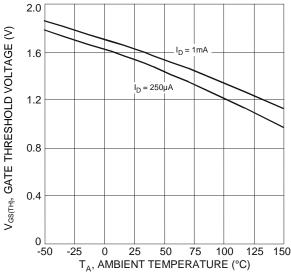
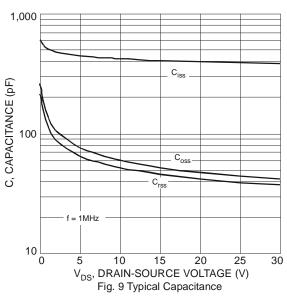
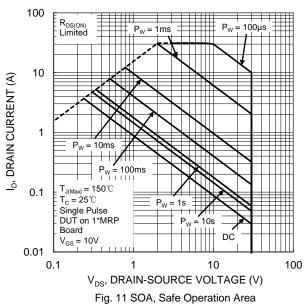
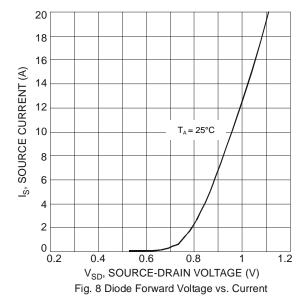
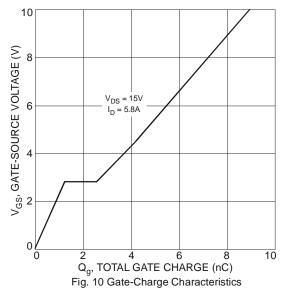


Fig. 7 Gate Threshold Variation vs. Ambient Temperature











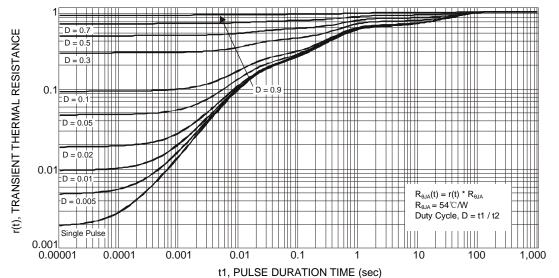


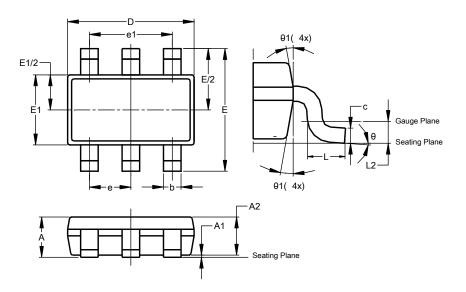
Fig. 12 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

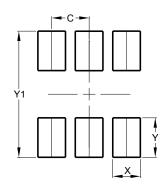


TSOT26							
Dim	Min	Max	Тур				
Α	-	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
Е	2	2.800 BS	C				
E1	1.500 1.700 1		1.600				
b	0.300	0.300 0.450 -					
С	0.120 0.200 -						
е	0.950 BSC						
e1	1.900 BSC						
L	0.30	0.50	_				
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	-				
Α	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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